# 2Gb DDR3L SDRAM 

## Lead-Free\&Halogen-Free (RoHS Compliant) H5TC2G43AFR-xxA H5TC2G83AFR-xxA

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## Иทиіх

## Revision History

| Revision No. | History | Draft Date | Remark |
| :---: | :---: | :---: | :---: |
| 0.1 | Initial Release | Nov. 2009 | Preliminary |

## Иทиіх

## Description

The H5TC2G43AFR-xxA, H5TC2G83AFR-xxA are a 2Gb low power Double Data Rate III (DDR3L) Synchronous DRAM, ideally suited for the main memory applications which requires large memory density, high bandwidth and low power operation at 1.35V. Hynix DDR3L SDRAM provides backward compatibility with the 1.5V DDR3 based environment without any changes. (Please refer to the SPD information for details.) Hynix 2Gb DDR3L SDRAMs offer fully synchronous operations referenced to both rising and falling edges of the clock. While all addresses and control inputs are latched on the rising edges of the clock (falling edges of the clock), data, data strobes and write data masks inputs are sampled on both rising and falling edges of it. The data paths are internally pipelined and 8 -bit prefetched to achieve very high bandwidth.

## Device Features and Ordering I nformation

## FEATURES

- $\mathrm{VDD}=\mathrm{VDDQ}=1.35 \mathrm{~V}+0.100 /-0.067 \mathrm{~V}$
- Fully differential clock inputs (CK, $\overline{\mathrm{CK}}$ ) operation
- Differential Data Strobe (DQS, $\overline{\mathrm{DQS}})$
- On chip DLL align DQ, DQS and $\overline{D Q S}$ transition with CK transition
- DM masks write data-in at the both rising and falling edges of the data strobe
- All addresses and control inputs except data, data strobes and data masks latched on the rising edges of the clock
- Programmable CAS latency 6, 7, 8, 9, 10 and (11) supported
- Programmable additive latency $0, \mathrm{CL}-1$, and $\mathrm{CL}-2$ supported
- Programmable CAS Write latency (CWL) $=5,6,7,8$
- Programmable burst length $4 / 8$ with both nibble sequential and interleave mode
- BL switch on the fly
* This product in compliance with the RoHS directive.

ORDERI NG I NFORMATI ON

| Part No. | Configuration | Package |
| :---: | :---: | :---: |
| H5TC2G43AFR- $* x x A$ | $512 \mathrm{M} \times 4$ | 82 ball FBGA |
| H5TC2G83AFR-*xxA | $256 \mathrm{M} \times 8$ |  |

OPERATI NG FREQUENCY

| Speed <br> Grade <br> (Marking) | Frequency [MHz] |  |  |  |  |  |  | Remark <br> (CL-tRCD-tRP) |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  | CL5 | CL6 | CL7 | CL8 | CL9 | CL10 | CL11 |  |
| $-\mathrm{G7}$ |  | 0 | 0 | 0 |  |  |  | DDR3L-1066 7-7-7 |
| $-H 9$ |  | 0 | 0 | 0 | 0 | 0 |  | DDR3L-1333 9-9-9 |

* xx means Speed Bin Grade


## Package Ballout/ Mechanical Dimension

 x4 Package Ball out (Top view): 82ball FBGA Package| 1 | 2 | 3 | 4 | 5 | 6 | 7 | 8 | 9 | 10 | 11 |
| :--- | :--- | :--- | :--- | :--- | :--- | :--- | :--- | :--- | :--- | :--- |


| A | NC | VSS | VDD | NC |
| :---: | :---: | :---: | :---: | :---: |
| B |  | VSS | VSSQ | DQ0 |
| C |  | VDDQ | DQ2 | DQS |
| D |  | VSSQ | NF | DQS |
| E |  | VREFDQ | VDDQ | NF |
| F |  | NC | vSS | $\overline{\text { RAS }}$ |
| G |  | ODT | VDD | CAS |
| H |  | NC | $\overline{C S}$ | $\overline{\text { WE }}$ |
| J |  | VSS | BAO | BA2 |
| K |  | VDD | A3 | A0 |
| L |  | VSS | A5 | A2 |
| M |  | VDD | A7 | A9 |
| N | NC | VSS | RESET | A13 |


| NF | VSS | VDD | NC |
| :---: | :---: | :---: | :---: |
| DM | VSSQ | VDDQ |  |
| DQ1 | DQ3 | VSSQ |  |
| VDD | VSS | VSSQ |  |
| NF | NF | VDDQ |  |
| CK | VSS | NC |  |
| $\overline{\text { CK }}$ | VDD | CKE |  |
| A10/AP | ZQ | NC |  |
| NC | VREFCA | VSS |  |
| A12/BC | BA1 | VDD |  |
| A1 | A4 | VSS |  |
| A11 | A6 | VDD |  |
| A14 | A8 | VSS | NC |


| 1 | 2 | 3 | 4 | 5 | 6 | 7 | 8 | 9 | 10 | 11 |
| :--- | :--- | :--- | :--- | :--- | :--- | :--- | :--- | :--- | :--- | :--- |

Note: NF (No Function) - This is applied to balls only used in x 4 configuration.

|  | 1234 | 891011 |  |
| :---: | :---: | :---: | :---: |
| A | $\bigcirc \bigcirc \bigcirc 0$ | $\bigcirc \bigcirc \bigcirc 0$ |  |
| B | $\bigcirc \bigcirc \bigcirc$ | $\bigcirc \bigcirc \bigcirc$ |  |
| C | $\bigcirc \bigcirc \bigcirc$ | $\bigcirc \bigcirc \bigcirc$ |  |
| D | $\bigcirc \bigcirc \bigcirc$ | $\bigcirc \bigcirc \bigcirc$ |  |
| E | $\bigcirc \bigcirc \bigcirc$ | $\bigcirc \bigcirc \bigcirc$ |  |
| F | $\bigcirc \bigcirc \bigcirc$ | $\bigcirc \bigcirc \bigcirc$ |  |
| G | $\bigcirc \bigcirc \bigcirc$ | $\bigcirc \bigcirc \bigcirc$ | (Top View: See the balls through the Package) |
| H | $\bigcirc \bigcirc \bigcirc$ | $\bigcirc \bigcirc \bigcirc$ | $\bigcirc$ Populated ball |
| J | $\bigcirc \bigcirc \bigcirc$ | $\bigcirc \bigcirc \bigcirc$ | + Ball not populated |
| K | $\bigcirc \bigcirc \bigcirc$ | $\bigcirc \bigcirc \bigcirc$ |  |
| L | $\bigcirc \bigcirc \bigcirc$ | $\bigcirc \bigcirc \bigcirc$ |  |
| M | $\bigcirc \bigcirc \bigcirc$ | $\bigcirc \bigcirc \bigcirc$ |  |
| N | $\bigcirc \bigcirc \bigcirc 0$ | $\bigcirc \bigcirc \bigcirc 0$ |  |

## x8 Package Ball out (Top view): 82ball FBGA Package

| 1 | 2 | 3 | 4 | 5 | 6 | 7 | 8 | 9 | 10 | 11 |
| :--- | :--- | :--- | :--- | :--- | :--- | :--- | :--- | :--- | :--- | :--- |


| A | NC | vSs | VDD | NC |  |  |  | NU/TDQS | VSS | VDD | NC |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| B |  | VSS | VSSQ | DQ0 |  |  |  | DM/TDQS | VSSQ | VDDQ |  |
| C |  | VDDQ | DQ2 | DQS |  |  |  | DQ1 | DQ3 | VSSQ |  |
| D |  | VSSQ | DQ6 | DQS |  |  |  | VDD | VSS | VSSQ |  |
| E |  | VREFDQ | VDDQ | DQ4 |  |  |  | DQ7 | DQ5 | VDDQ |  |
| F |  | NC | VSS | RAS |  |  |  | CK | VSS | NC |  |
| G |  | ODT | VDD | CAS |  |  |  | $\overline{\text { CK }}$ | VDD | CKE |  |
| H |  | NC | CS | $\overline{\text { WE }}$ |  |  |  | A10/AP | ZQ | NC |  |
| J |  | VSS | BAO | BA2 |  |  |  | NC | VREFCA | VSS |  |
| K |  | VDD | A3 | A0 |  |  |  | A12/BC | BA1 | VDD |  |
| L |  | vSS | A5 | A2 |  |  |  | A1 | A4 | vSS |  |
| M |  | VDD | A7 | A9 |  |  |  | A11 | A6 | VDD |  |
| N | NC | vSs | $\overline{\text { RESET }}$ | A13 |  |  |  | A14 | A8 | vSS | NC |
|  | 1 | 2 | 3 | 4 | 5 | 6 |  | 8 | 9 | 10 | 11 |

1234

| A | 0000 | 0000 |
| :---: | :---: | :---: |
| B | 000 | 000 |
| c | 000 | 000 |
| D | 000 | 000 |
| E | 000 | 000 |
| F | 000 | 000 |
| G | 000 | 000 |
| H | 000 | 000 |
| J | 000 | 000 |
| $k$ | 000 | 000 |
| L | $\bigcirc 00$ | 000 |
| m | $\bigcirc 00$ | $\bigcirc 00$ |
| $N$ | $\bigcirc 000$ | $\bigcirc 000$ |

(Top View: See the balls through the Package)

O Populated ball

+ Ball not populated


## Pin Functional Description

| Symbol | Type | Function |
| :---: | :---: | :---: |
| $\mathrm{CK}, \overline{\mathrm{CK}}$ | Input | Clock: CK and $\overline{\mathrm{CK}}$ are differential clock inputs. All address and control input signals are sampled on the crossing of the positive edge of CK and negative edge of $\overline{\mathrm{CK}}$. |
| CKE, (CKEO), (CKE1) | Input | Clock Enable: CKE HIGH activates, and CKE Low deactivates, internal clock signals and device input buffers and output drivers. Taking CKE Low provides Precharge Power-Down and Self-Refresh operation (all banks idle), or Active Power-Down (row Active in any bank). <br> CKE is asynchronous for Self-Refresh exit. After VREFCA and VREFDQ have become stable during the power on and initialization sequence, they must be maintained during all operations (including Self-Refresh). CKE must be maintained high throughout read and write accesses. Input buffers, excluding CK, $\overline{C K}$, ODT and CKE, are disabled during powerdown. Input buffers, excluding CKE, are disabled during Self-Refresh. |
| $\begin{gathered} \overline{\mathrm{CS}},(\overline{\mathrm{CS}} 0), \\ (\overline{\mathrm{CS}} 1),(\overline{\mathrm{CS}} 2), \\ (\overline{\mathrm{CS}} 3) \end{gathered}$ | Input | Chip Select: All commands are masked when $\overline{\mathrm{CS}}$ is registered HIGH. $\overline{\mathrm{CS}}$ provides for external Rank selection on systems with multiple Ranks. $\overline{\mathrm{CS}}$ is considered part of the command code. |
| ODT, (ODTO) (ODT1) | Input | On Die Termination: ODT (registered HIGH) enables termination resistance internal to the DDR3 SDRAM. When enabled, ODT is only applied to each DQ, DQS, $\overline{D Q S}$ and DM/TDQS, NU/TDQS (When TDQS is enabled via Mode Register A11=1 in MR1) signal for $x 4 / \mathrm{x} 8$ configurations. For x16 configuration, ODT is applied to each DQ, DQSU, $\overline{D Q S U}, ~ D Q S L$, $\overline{\mathrm{DQSL}}, \mathrm{DMU}$, and DML signal. The ODT pin will be ignored if MR1 is programmed to disable ODT. |
| $\frac{\overline{\mathrm{RAS}}}{\mathrm{CAS}} \overline{\mathrm{WE}}$ | Input | Command Inputs: $\overline{\mathrm{RAS}}, \overline{\mathrm{CAS}}$ and $\overline{\mathrm{WE}}$ (along with $\overline{\mathrm{CS}}$ ) define the command being entered. |
| $\begin{gathered} \text { DM, (DMU), } \\ \text { (DML) } \end{gathered}$ | Input | Input Data Mask: DM is an input mask signal for write data. Input data is masked when DM is sampled HIGH coincident with that input data during a Write access. DM is sampled on both edges of DQS. For x8 device, the function of DM or TDQS/TDQS is enabled by Mode Register A11 setting in MR1. |
| BAO-BA2 | Input | Bank Address Inputs: BA0 - BA2 define to which bank an Active, Read, Write or Precharge command is being applied. Bank address also determines if the mode register or extended mode register is to be accessed during a MRS cycle. |
| A0-A15 | Input | Address Inputs: Provide the row address for Active commands and the column address for Read/Write commands to select one location out of the memory array in the respective bank. (A10/AP and A12/BC have additional functions, see below). <br> The address inputs also provide the op-code during Mode Register Set commands. |
| A10 / AP | Input | Auto-precharge: A10 is sampled during Read/Write commands to determine whether Autoprecharge should be performed to the accessed bank after the Read/Write operation. (HIGH: Autoprecharge; LOW: no Autoprecharge).A10 is sampled during a Precharge command to determine whether the Precharge applies to one bank (A10 LOW) or all banks (A10 HIGH). If only one bank is to be precharged, the bank is selected by bank addresses. |
| A12 / $\overline{B C}$ | Input | Burst Chop: A12 / $\overline{\mathrm{BC}}$ is sampled during Read and Write commands to determine if burst chop (on-the-fly) will be performed. <br> (HIGH, no burst chop; LOW: burst chopped). See command truth table for details. |

## Ициіх

| Symbol | Type | Function |
| :---: | :---: | :---: |
| $\overline{\text { RESET }}$ | Input | Active Low Asynchronous Reset: Reset is active when $\overline{\text { RESET }}$ is LOW, and inactive when $\overline{\text { RESET }}$ is HIGH. $\overline{\text { RESET }}$ must be HIGH during normal operation. $\overline{\text { RESET }}$ is a CMOS rail-to-rail signal with DC high and low at $80 \%$ and $20 \%$ of $V_{D D}$, i.e. 1.20V for DC high and 0.30V for DC low. |
| DQ | Input/ Output | Data Input/ Output: Bi-directional data bus. |
|  | Input / Output | Data Strobe: output with read data, input with write data. Edge-aligned with read data, centered in write data. The data strobe DQS, DQSL, and DQSU are paired with differential signals $\overline{\mathrm{DQS}}, \overline{\mathrm{DQSL}}$, and $\overline{\mathrm{DQSU}}$, respectively, to provide differential pair signaling to the system during reads and writes. DDR3 SDRAM supports differential data strobe only and does not support single-ended. |
| TDQS, $\overline{\text { TDQS }}$ | Output | Termination Data Strobe: TDQS/ $\overline{\overline{T D Q S}}$ is applicable for x8 DRAMs only. When enabled via Mode Register A11 = 1 in MR1, the DRAM will enable the same termination resistance function on TDQS/ $\overline{\operatorname{TDQS}}$ that is applied to DQS/ $\overline{\mathrm{DQS}}$. When disabled via mode register A11 $=0$ in MR1, DM/TDQS will provide the data mask function and TDQS is not used. $\times 4 / \times 16$ DRAMs must disable the TDQS function via mode register A11 $=0$ in MR1. |
| NC |  | No Connect: No internal electrical connection is present. |
| NF |  | No Function |
| $V_{\text {DDQ }}$ | Supply | DQ Power Supply: $1.5 \mathrm{~V}+/-0.075 \mathrm{~V}$ |
| $V_{\text {SSQ }}$ | Supply | DQ Ground |
| $\mathrm{V}_{\mathrm{DD}}$ | Supply | Power Supply: $1.5 \mathrm{~V}+/-0.075 \mathrm{~V}$ |
| $\mathrm{V}_{\text {S }}$ | Supply | Ground |
| $\mathrm{V}_{\text {RefDQ }}$ | Supply | Reference voltage for DQ |
| $V_{\text {REFCA }}$ | Supply | Reference voltage for CA |
| ZQ | Supply | Reference Pin for ZQ calibration |

Note:
Input only pins (BAO-BA2, A0-A15, $\overline{\mathrm{RAS}}, \overline{\mathrm{CAS}}, \overline{\mathrm{WE}}, \overline{\mathrm{CS}}, \mathrm{CKE}, \mathrm{ODT}, \mathrm{DM}$, and $\overline{\mathrm{RESET}}$ ) do not supply termination.

## ROW AND COLUMN ADDRESS TABLE

2Gb

| Configuration | $\mathbf{5 1 2 M b} \mathbf{x 4}$ | $\mathbf{2 5 6 M b} \mathbf{x} \mathbf{8}$ |
| :--- | :---: | :---: |
| $\#$ of Banks | 8 | 8 |
| Bank Address | $\mathrm{BA} 0-\mathrm{BA} 2$ | $\mathrm{BA} 0-\mathrm{BA} 2$ |
| Auto precharge | $\mathrm{A} 10 / \mathrm{AP}$ | $\mathrm{A} 10 / \mathrm{AP}$ |
| BL switch on the fly | $\mathrm{A} 12 / \overline{\mathrm{BC}}$ | $\mathrm{A} 12 / \overline{\mathrm{BC}}$ |
| Row Address | $\mathrm{A} 0-\mathrm{A} 14$ | $\mathrm{~A} 0-\mathrm{A} 14$ |
| Column Address | $\mathrm{A} 0-\mathrm{A} 9, \mathrm{~A} 11$ | $\mathrm{~A} 0-\mathrm{A} 9$ |
| Page size ${ }^{1}$ | 1 KB | 1 KB |

Notel: Page size is the number of bytes of data delivered from the array to the internal sense amplifiers when an ACTIVE command is registered. Page size is per bank, calculated as follows:
page size $=2{ }^{\text {COLBITS }} *$ ORG $\div 8$
where COLBITS = the number of column address bits, ORG = the number of $I / O$ (DQ) bits

## Absolute Maximum Ratings

## Absolute Maximum DC Ratings

## Absolute Maximum DC Ratings

| Symbol | Parameter | Rating | Units | Notes |
| :---: | :--- | :---: | :---: | :---: |
| VDD | Voltage on VDD pin relative to Vss | $-0.4 \mathrm{~V} \sim 1.975 \mathrm{~V}$ | V | 1,3 |
| VDDQ | Voltage on VDDQ pin relative to Vss | $-0.4 \mathrm{~V} \sim 1.975 \mathrm{~V}$ | V | 1,3 |
| $\mathrm{~V}_{\text {IN }}, \mathrm{V}_{\text {OUT }}$ | Voltage on any pin relative to Vss | $-0.4 \mathrm{~V} \sim 1.975 \mathrm{~V}$ | V | 1 |
| $\mathrm{~T}_{\text {STG }}$ | Storage Temperature | -55 to +100 | ${ }^{\circ} \mathrm{C}$ | 1,2 |

Notes:

1. Stresses greater than those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect reliability.
2. Storage Temperature is the case surface temperature on the center/top side of the DRAM. For the measurement conditions, please refer to JESD51-2 standard.
3. VDD and VDDQ must be within 300 mV of each other at all times; and VREF must not be greater than 0.6 XVDDQ, When VDD and VDDQ are less than 500 mV ; VREF may be equal to or less than 300 mV .

## DRAM Component Operating Temperature Range Temperature Range

| Symbol | Parameter | Rating | Units | Notes |
| :---: | :--- | :---: | :---: | :---: |
| $\mathrm{T}_{\text {OPER }}$ | Normal Operating Temperature Range | 0 to 85 | ${ }^{\circ} \mathrm{C}$ | 1,2 |
|  | Extended Temperature Range (Optional) | 85 to 95 | ${ }^{\circ} \mathrm{C}$ | 1,3 |

## Notes:

1. Operating Temperature TOPER is the case surface temperature on the center / top side of the DRAM. For measurement conditions, please refer to the JEDEC document JESD51-2.
2. The Normal Temperature Range specifies the temperatures where all DRAM specifications will be supported. During operation, the DRAM case temperature must be maintained between $0-85^{\circ} \mathrm{C}$ under all operating conditions.
3. Some applications require operation of the DRAM in the Extended Temperature Range between $85^{\circ} \mathrm{C}$ and $95^{\circ} \mathrm{C}$ case temperature. Full specifications are guaranteed in this range, but the following additional conditions apply:
a. Refresh commands must be doubled in frequency, therefore reducing the Refresh interval tREFI to $3.9 \mu \mathrm{~s}$. It is also possible to specify a component with 1 X refresh (tREFI to $7.8 \mu \mathrm{~s}$ ) in the Extended Temperature Range. Please refer to the DIMM SPD for option availability
b. If Self-Refresh operation is required in the Extended Temperature Range, then it is mandatory to either use the Manual Self-Refresh mode with Extended Temperature Range capability (MR2 A6 = 0b and MR2 A7 = 1b) or enable the optional Auto Self-Refresh mode (MR2 A6 = 1b and MR2 A7 = Ob).

## AC \& DC Operating Conditions

## Recommended DC Operating Conditions

Recommended DC Operating Conditions - DDR3L (1.35V) operation

| Symbol | Parameter | Rating |  |  | Units | Notes |
| :---: | :--- | :---: | :---: | :---: | :---: | :---: |
|  |  | Min. | Typ. | Max. |  |  |
| VDD |  | 1.283 | 1.35 | 1.45 | V | $1,2,3,4$ |
| VDDQ | Supply Voltage for Output | 1.283 | 1.35 | 1.45 | V | $1,2,3,4$ |

Notes:

1. Maximum DC value may not be greater than 1.425 V . The DC value is the linear average of VDD/VDDQ ( t ) over a very long period of time (e.g., 1 sec ).
2. If maximum limit is exceeded, input levels shall be governed by DDR3 specifications.
3. Under these supply voltages, the device operates to this DDR3L specification.
4. Once initialized for DDR3L operation, DDR3 operation may only be used if the device is in reset while VDD and VDDQ are changed for DDR3 operation (see Figure 0).

Recommended DC Operating Conditions - DDR3 (1.5V) operation

| Symbol | Parameter | Rating |  |  | Units | Notes |
| :---: | :--- | :---: | :---: | :---: | :---: | :---: |
|  |  | Min. | Typ. | Max. |  |  |
| VDD |  | 1.425 | 1.5 | 1.575 | $1,2,3$ |  |
| VDDQ | Supply Voltage for Output | 1.425 | 1.5 | 1.575 | V | $1,2,3$ |

## Notes:

1. If minimum limit is exceeded, input levels shall be governed by DDR3L specifications.
2. Under 1.5 V operation, this DDR3L device operates to the DDR3 specifications under the same speed timings as defined for this device.
3. Once initialized for DDR3 operation, DDR3L operation may only be used if the device is in reset while VDD and VDDQ are changed for DDR3L operation (see Figure 0).

## Иทиіх



Figure 0 - VDD/VDDQ Voltage Switch Between DDR3L and DDR3

## I DD and I DDQ Specification Parameters and Test Conditions IDD and IDDQ Measurement Conditions

In this chapter, IDD and IDDQ measurement conditions such as test load and patterns are defined. Figure 1. shows the setup and test load for IDD and IDDQ measurements.

- IDD currents (such as IDD0, IDD1, IDD2N, IDD2NT, IDD2P0, IDD2P1, IDD2Q, IDD3N, IDD3P, IDD4R, IDD4W, IDD5B, IDD6, IDD6ET, IDD6TC and IDD7) are measured as time-averaged currents with all VDD balls of the DDR3 SDRAM under test tied together. Any IDDQ current is not included in IDD currents.
- IDDQ currents (such as IDDQ2NT and IDDQ4R) are measured as time-averaged currents with all VDDQ balls of the DDR3 SDRAM under test tied together. Any IDD current is not included in IDDQ currents.
Attention: IDDQ values cannot be directly used to calculate IO power of the DDR3 SDRAM. They can be used to support correlation of simulated 10 power to actual 10 power as outlined in Figure 2. In DRAM module application, IDDQ cannot be measured separately since VDD and VDDQ are using one merged-power layer in Module PCB.

For IDD and IDDQ measurements, the following definitions apply:

- " 0 " and "LOW" is defined as VIN $<=\mathrm{V}_{\text {ILAC(max) }}$.
- " 1 " and "HIGH" is defined as VIN $>=\mathrm{V}_{\text {IHAC(max) }}$.
- "MID_LEVEL" is defined as inputs are VREF = VDD/2.
- Timing used for IDD and IDDQ Measurement-Loop Patterns are provided in Table 1.
- Basic IDD and IDDQ Measurement Conditions are described in Table 2.
- Detailed IDD and IDDQ Measurement-Loop Patterns are described in Table 3 through Table 10.
- IDD Measurements are done after properly initializing the DDR3 SDRAM. This includes but is not limited to setting
RON $=$ RZQ/7 (34 Ohm in MR1);
Qoff $=0_{B}$ (Output Buffer enabled in MR1);
RTT_Nom = RZQ/6 ( 40 Ohm in MR1);
RT_-Wr = RZQ/2 (120 Ohm in MR2);
TDQS Feature disabled in MR1
- Attention: The IDD and IDDQ Measurement-Loop Patterns need to be executed at least one time before actual IDD or IDDQ measurement is started.
- Define $\mathrm{D}=\{\overline{\mathrm{CS}}, \overline{\mathrm{RAS}}, \overline{\mathrm{CAS}}, \overline{\mathrm{WE}}\}:=\{\mathrm{HIGH}$, LOW, LOW, LOW $\}$
- Define $\overline{\mathrm{D}}=\{\overline{\mathrm{CS}}, \overline{\mathrm{RAS}}, \overline{\mathrm{CAS}}, \overline{\mathrm{WE}}\}:=\{\mathrm{HIGH}, \mathrm{HIGH}, \mathrm{HIGH}, \mathrm{HIGH}\}$


Figure 1 - Measurement Setup and Test Load for IDD and IDDQ (optional) Measurements [Note: DIMM level Output test load condition may be different from above]


Figure 2 - Correlation from simulated Channel IO Power to actual Channel IO Power supported by IDDQ Measurement

## Иทиіх

## Table 1 -Timings used for I DD and I DDQ Measurement-Loop Patterns

| Symbol | DDR3-1066 | DDR3-1333 | Unit |
| :---: | :---: | :---: | :---: |
|  | 7-7-7 | 9-9-9 |  |
| $t_{\mathrm{CK}}$ | 1.875 | 1.5 | ns |
| CL | 7 | 9 | nCK |
| $n_{\text {RCD }}$ | 7 | 9 | nCK |
| $n_{\text {RC }}$ | 27 | 33 | nCK |
| $n_{\text {RAS }}$ | 20 | 24 | nCK |
| $n_{\text {RP }}$ | 7 | 9 | nCK |
|  | 20 | 20 | nCK |
| $n_{\text {FAW }}{ }^{\text {a }}$ 2KB page size | 27 | 30 | nCK |
| $n_{\text {FRD }}$ 1KB page size | 4 | 4 | nCK |
| $n_{\text {RRD }}{ }^{\text {a }}$ | 6 | 5 | nCK |
| $n_{\text {RFC }}-512 \mathrm{Mb}$ | 48 | 60 | nCK |
| $n_{\text {RFC }}{ }^{-1 ~ G b}$ | 59 | 74 | nCK |
| $n_{\text {RFC }}{ }^{-2 \mathrm{~Gb}}$ | 86 | 107 | nCK |
| $n_{\text {RFC }}-4 \mathrm{~Gb}$ | 160 | 200 | nCK |
| $n_{\text {RFC }}{ }^{-8 \mathrm{~Gb}}$ | 187 | 234 | nCK |

## Table 2 -Basic I DD and IDDQ Measurement Conditions

| Symbol | Description |
| :---: | :---: |
| /DDO | Operating One Bank Active-Precharge Current <br> CKE: High; External clock: On; tCK, nRC, nRAS, CL: see Table 1; BL: $8^{\text {a) }}$; AL: 0; $\overline{\mathrm{CS}}$ : High between ACT and PRE; Command, Address, Bank Address Inputs: partially toggling according to Table 3; Data IO: MID-LEVEL; DM: stable at 0; Bank Activity: Cycling with one bank active at a time: $0,0,1,1,2,2, \ldots$ ( see Table 3); Output Buffer and RTT: Enabled in Mode Registers ${ }^{\text {b }}$; ODT Signal: stable at 0; Pattern Details: see Table 3. |
| /DD1 | Operating One Bank Active-Precharge Current <br> CKE: High; External clock: On; tCK, nRC, nRAS, nRCD, CL: see Table 1; BL: $8^{\mathrm{a})}$; AL: 0; $\overline{\mathrm{CS}}$ : High between ACT, RD and PRE; Command, Address; Bank Address Inputs, Data IO: partially toggling according to Table 4; DM: stable at 0; Bank Activity: Cycling with on bank active at a time: $0,0,1,1,2,2, \ldots$ (see Table 4); Output Buffer and RTT: Enabled in Mode Registers ${ }^{\text {b) }}$; ODT Signal: stable at 0; Pattern Details: see Table 4. |

## Ициіх

| Symbol | Description |
| :---: | :---: |
| /DD2N | Precharge Standby Current <br> CKE: High; External clock: On; tCK, CL: see Table 1; BL: $8^{\text {a) }}$; AL: 0; $\overline{\mathrm{CS}}$ : stable at 1; Command, Address, Bank Address Inputs: partially toggling according to Table 5; Data IO: MID_LEVEL; DM: stable at 0; Bank Activity: all banks closed; Output Buffer and RTT: Enabled in Mode Registers ${ }^{\text {b }}$; ODT Signal: stable at 0; Pattern Details: see Table 5. |
| /DD2NT | Precharge Standby ODT Current <br> CKE: High; External clock: On; tCK, CL: see Table 1; BL: 8 ${ }^{\text {a) }}$; AL: 0; $\overline{\mathrm{CS}}$ : stable at 1; Command, Address, Bank Address Inputs: partially toggling according to Table 6; Data IO: MID_LEVEL; DM: stable at 0; Bank Activity: all banks closed; Output Buffer and RTT: Enabled in Mode Registers ${ }^{\text {b }}$; ODT Signal: toggling according to Table 6; Pattern Details: see Table 6. |
| /DDQ2NT <br> (optional) | Precharge Standby ODT IDDQ Current <br> Same definition like for IDD2NT, however measuring IDDQ current instead of IDD current |
| /DD2P0 | Precharge Power-Down Current Slow Exit <br> CKE: Low; External clock: On; tCK, CL: see Table 1; BL: $8^{\mathrm{a})}$; AL: 0; $\overline{\mathrm{CS}}$ : stable at 1 ; Command, Address, Bank Address Inputs: stable at 0; Data IO: MID_LEVEL; DM: stable at 0; Bank Activity: all banks closed; Output Buffer and RTT: Enabled in Mode Registers ${ }^{\text {b) }}$; ODT Signal: stable at 0; Precharge Power Down Mode: Slow Exit ${ }^{\text {c) }}$ |
| /DD2P1 | Precharge Power-Down Current Fast Exit <br> CKE: Low; External clock: On; tCK, CL: see Table 1; BL: $8^{\mathrm{a})}$; AL: 0; $\overline{\mathrm{CS}}$ : stable at 1 ; Command, Address, Bank Address Inputs: stable at 0; Data IO: MID_LEVEL; DM: stable at 0; Bank Activity: all banks closed; Output Buffer and RTT: Enabled in Mode Registers ${ }^{\text {b }}$; ODT Signal: stable at 0; Precharge Power Down Mode: Fast Exit ${ }^{\text {C }}$ |
| /DD2Q | Precharge Quiet Standby Current <br> CKE: High; External clock: On; tCK, CL: see Table 1; BL: $8^{\mathrm{a}}$; AL: 0; $\overline{\mathrm{CS}}$ : stable at 1; Command, Address, Bank Address Inputs: stable at 0; Data IO: MID_LEVEL; DM: stable at 0; Bank Activity: all banks closed; Output Buffer and RTT: Enabled in Mode Registers ${ }^{\text {b) }}$; ODT Signal: stable at 0 |
| /DD3N | Active Standby Current <br> CKE: High; External clock: On; tCK, CL: see Table 1; BL: 8a); AL: 0; $\overline{\mathrm{CS}}$ : stable at 1; Command, Address, Bank Address Inputs: partially toggling according to Table 5; Data IO: MID_LEVEL; DM: stable at 0; Bank Activity: all banks open; Output Buffer and RTT: Enabled in Mode Registers ${ }^{\text {b }}$; ODT Signal: stable at 0; Pattern Details: see Table 5. |

## Ициіх

| Symbol | Description |
| :---: | :---: |
| /DD3P | Active Power-Down Current <br> CKE: Low; External clock: On; tCK, CL: see Table 1; BL: $8^{\mathrm{a}}$; AL: 0; $\overline{\mathrm{CS}}$ : stable at 1 ; Command, Address, Bank Address Inputs: stable at 0; Data IO: MID_LEVEL; DM: stable at 0; Bank Activity: all banks open; Output Buffer and RTT: Enabled in Mode Registers ${ }^{\text {b) }}$; ODT Signal: stable at 0 |
| IDDQ4R <br> (optional) | Operating Burst Read IDDQ Current <br> Same definition like for IDD4R, however measuring IDDQ current instead of IDD current |
| /DD4R | Operating Burst Read Current <br> CKE: High; External clock: On; tCK, CL: see Table 1; BL: $8^{\mathrm{a}}$; AL: 0; $\overline{\mathrm{CS}}$ : High between RD; Command, Address, Bank Address Inputs: partially toggling according to Table 7; Data IO: seamless read data burst with different data between one burst and the next one according to Table 7; DM: stable at 0; Bank Activity: all banks open, RD commands cycling through banks: $0,0,1,1,2,2, \ldots$ (see Table 7); Output Buffer and RTT: Enabled in Mode Registers ${ }^{\text {b }}$; ODT Signal: stable at 0; Pattern Details: see Table 7. |
| /DD4w | Operating Burst Write Current <br> CKE: High; External clock: On; tCK, CL: see Table 1; BL: $8^{a}$; AL: 0; $\overline{C S}$ : High between WR; Command, Address, Bank Address Inputs: partially toggling according to Table 8; Data IO: seamless read data burst with different data between one burst and the next one according to Table 8; DM: stable at 0; Bank Activity: all banks open, WR commands cycling through banks: $0,0,1,1,2,2, \ldots$ (see Table 8); Output <br> Buffer and RTT: Enabled in Mode Registers ${ }^{\text {b }}$; ODT Signal: stable at HIGH; Pattern Details: see Table 8. |
| /DD5B | Burst Refresh Current <br> CKE: High; External clock: On; tCK, CL, nRFC: see Table 1; BL: $8^{\mathrm{a})}$; AL: 0 ; $\overline{C S}$ : High between REF; Command, Address, Bank Address Inputs: partially toggling according to Table 9; Data IO: MID_LEVEL; DM: stable at 0; Bank Activity: REF command every nREF (see Table 9); Output Buffer and RTT: Enabled in Mode Registers ${ }^{\text {b }}$; ODT Signal: stable at 0; Pattern Details: see Table 9. |
| /DD6 | Self-Refresh Current: Normal Temperature Range TCASE: $^{\text {0 }}-85^{\circ} \mathrm{C}$; Auto Self-Refresh (ASR): Disabled ${ }^{\text {d) }}$; Self-Refresh Temperature Range (SRT): Normal ${ }^{\mathrm{e}}$; CKE: Low; External clock: Off; CK and $\overline{C K}$ : LOW; CL: see Table 1; BL: $8^{\text {a) } ; ~ A L: ~ 0 ; ~} \overline{C S}$, Command, Address, Bank Address Inputs, Data IO: MID_LEVEL; DM: stable at 0; Bank Activity: Self-Refresh operation; Output Buffer and RTT: Enabled in Mode Registers ${ }^{\text {b) }}$; ODT Signal: MID_LEVEL |

## Ициіх

| Symbol | Description |
| :---: | :---: |
| /DD6ET | Self-Refresh Current: Extended Temperature Range (optional) ${ }^{\text {f }}$ ) <br> $\boldsymbol{T}_{\text {CASE: }}$ 0-95 ${ }^{\circ} \mathrm{C}$; Auto Self-Refresh (ASR): Disabled ${ }^{\mathrm{d})}$; Self-Refresh Temperature Range (SRT): Extended $^{\mathrm{e}}$; CKE: Low; External clock: Off; CK and $\overline{\mathrm{CK}}$ : LOW; CL: see Table 1; BL: $8^{\mathrm{a})}$; AL: 0; $\overline{\mathrm{CS}}, \mathrm{Command}$, Address, Bank Address Inputs, Data IO: MID_LEVEL; DM: stable at 0; Bank Activity: Extended Temperature Self-Refresh operation; Output Buffer and RTT: Enabled in Mode Registers ${ }^{\text {b }}$; ODT Signal: MID LEVEL |
| /DD6TC | Auto Self-Refresh Current (optional) ${ }^{\mathrm{f}}$ ) <br> $\boldsymbol{T}_{\text {CASE: }}$ 0-95 ${ }^{\circ} \mathrm{C}$; Auto Self-Refresh (ASR): Enabled ${ }^{\mathrm{d})}$; Self-Refresh Temperature Range (SRT): Normal ${ }^{\mathrm{e}}$; CKE: Low; External clock: Off; CK and $\overline{C K}$ : LOW; CL: see Table 1; BL: $8^{\mathrm{a})}$; AL: 0; $\overline{\mathrm{CS}}, \mathrm{Command}$, Address, Bank Address Inputs, Data IO: MID_LEVEL; DM: stable at 0; Bank Activity: Auto Self-Refresh operation; Output Buffer and RTT: Enabled in Mode Registers ${ }^{\text {b) }}$; ODT Signal: MID_LEVEL |
| /DD7 | Operating Bank Interleave Read Current <br> CKE: High; External clock: On; tCK, nRC, nRAS, nRCD, NRRD, nFAW, CL: see Table 1; BL: $8^{\mathrm{a})}{ }^{\mathrm{f})}$; AL: CL1; $\overline{C S}$ : High between ACT and RDA; Command, Address, Bank Address Inputs: partially toggling according to Table 10; Data IO: read data burst with different data between one burst and the next one according to Table 10; DM: stable at 0; Bank Activity: two times interleaved cycling through banks (0, $1, \ldots 7$ ) with different addressing, wee Table 10; Output Buffer and RTT: Enabled in Mode Registers ${ }^{\text {b }}$; ODT Signal: stable at 0; Pattern Details: see Table 10. |

a) Burst Length: BL8 fixed by MRS: set MRO $A[1,0]=00 B$
b) Output Buffer Enable: set MR1 A[12] = 0B; set MR1 A[5,1] = 01B; RTT_Nom enable: set MR1 A[9,6,2] = 011B; RTT_Wr enable: set MR2 A[10,9] = 10B
c) Precharge Power Down Mode: set MR0 A12=0B for Slow Exit or MR0 A12 = 1B for Fast Exit
d) Auto Self-Refresh (ASR): set MR2 $A 6=0 B$ to disable or $1 B$ to enable feature
e) Self-Refresh Temperature Range (SRT): set MR2 A7 = $0 B$ for normal or $1 B$ for extended temperature range
f) Read Burst Type: Nibble Sequential, set MR0 A[3] = OB

## Иทиіх

## Table 3 －I DDO Measurement－Loop Pattern ${ }^{\text {a）}}$

| $\begin{array}{\|c} \text { IV } \\ \text { v } \end{array}$ | $\underset{\mathbf{V}}{\boldsymbol{v}}$ |  |  | $\begin{aligned} & \text { ס } \\ & \text { 见 } \\ & \text { E } \\ & \text { E } \\ & 0 \end{aligned}$ | 19 | $\left\lvert\, \begin{aligned} & 9 \\ & \hdashline \end{aligned}\right.$ | \|荇 | $1 \stackrel{w}{3}$ |  | $\begin{aligned} & \underset{\sim}{\dot{N}} \\ & \stackrel{N}{\mathbf{N}} \end{aligned}$ | $\begin{aligned} & \text { 글 } \\ & \text { ヘٌ̈ } \\ & \stackrel{\rightharpoonup}{4} \end{aligned}$ | $$ | $\begin{aligned} & \text { N } \\ & \text { ö } \\ & \hline \end{aligned}$ | M <br> 0 <br>  | ¢ | Data ${ }^{\text {b }}$ |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| $\begin{aligned} & \text { 을 } \\ & \text { 우 } \\ & \text { O} \end{aligned}$ |  | 0 | 0 | ACT | 0 | 0 | 1 | 1 | 0 | 0 | 00 | 0 | 0 | 0 | 0 | － |
|  |  |  | 1，2 | D，D | 1 | 0 | 0 | 0 | 0 | 0 | 00 | 0 | 0 | 0 | 0 | － |
|  |  |  | 3，4 | $\overline{\mathrm{D}}, \overline{\mathrm{D}}$ | 1 | 1 | 1 | 1 | 0 | 0 | 00 | 0 | 0 | 0 | 0 | － |
|  |  |  | ．．． | repeat pattern 1．．． 4 until nRAS－1，truncate if necessary |  |  |  |  |  |  |  |  |  |  |  |  |
|  |  |  | nRAS | PRE | 0 | 0 | 1 | 0 | 0 | 0 | 00 | 0 | 0 | 0 | 0 | － |
|  |  |  | ．．． | repeat pattern 1．．． 4 until nRC－1，truncate if necessary |  |  |  |  |  |  |  |  |  |  |  |  |
|  |  |  | $1 * n R C+0$ | ACT | 0 | 0 | 1 | 1 | 0 | 0 | 00 | 0 | 0 | F | 0 | － |
|  |  |  | $1 * n R C+1,2$ | D，D | 1 | 0 | 0 | 0 | 0 | 0 | 00 | 0 | 0 | F | 0 | － |
|  |  |  | $1 * n R C+3,4$ | $\overline{\mathrm{D}}, \overline{\mathrm{D}}$ | 1 | 1 | 1 | 1 | 0 | 0 | 00 | 0 | 0 | F | 0 | － |
|  |  |  | $\ldots$ | repeat pattern 1．．． 4 until $1 * n R C+n R A S-1$ ，truncate if necessary |  |  |  |  |  |  |  |  |  |  |  |  |
|  |  |  | $1 * n R C+n R A S$ | PRE | 0 | 0 | 1 | 0 | 0 | 0 | 00 | 0 | 0 | F | 0 | － |
|  |  |  | ．．． | repeat pattern 1．．． 4 until $2 * n R C-1$ ，truncate if necessary |  |  |  |  |  |  |  |  |  |  |  |  |
|  |  | 1 | 2＊nRC | repeat Sub－Loop 0，use BA［2：0］＝ 1 instead |  |  |  |  |  |  |  |  |  |  |  |  |
|  |  | 2 | 4＊nRC | repeat Sub－Loop 0，use BA［2：0］＝ 2 instead |  |  |  |  |  |  |  |  |  |  |  |  |
|  |  | 3 | 6＊nRC | repeat Sub－Loop 0，use BA［2：0］$=3$ instead |  |  |  |  |  |  |  |  |  |  |  |  |
|  |  | 4 | 8＊nRC | repeat Sub－Loop 0，use BA［2：0］＝ 4 instead |  |  |  |  |  |  |  |  |  |  |  |  |
|  |  | 5 | 10＊nRC | repeat Sub－Loop 0，use BA［2：0］＝5 instead |  |  |  |  |  |  |  |  |  |  |  |  |
|  |  | 6 | 12＊nRC | repeat Sub－Loop 0，use BA［2：0］＝ 6 instead |  |  |  |  |  |  |  |  |  |  |  |  |
|  |  | 7 | 14＊nRC | repeat Sub－Loop 0，use BA［2：0］＝ 7 instead |  |  |  |  |  |  |  |  |  |  |  |  |

a）DM must be driven LOW all the time．DQS，$\overline{\mathrm{DQS}}$ are MID－LEVEL．
b）DQ signals are MID－LEVEL．

## Иทиіх

## Table 4 - I DD1 Measurement-Loop Pattern ${ }^{\text {a) }}$

|  | $\underset{\mathbf{V}}{\boldsymbol{v}}$ | $\begin{aligned} & \text { 응 } \\ & 0 \\ & \text { ó } \\ & \text { ज } \end{aligned}$ | $\frac{\vdots}{\varrho} \frac{\frac{1}{0}}{\vdots}$ | D © E E 0 0 | 19 | $19$ | $\left.\right\|_{\substack{n}}$ | $\left\lvert\, \frac{w}{3}\right.$ | $\stackrel{1}{6}$ |  | $\begin{aligned} & \text { 글 } \\ & \text { ヘ̈ } \\ & \text { 구 } \end{aligned}$ | $\begin{gathered} \underset{\sim}{\mathbf{B}} \\ \stackrel{\rightharpoonup}{4} \end{gathered}$ | $\begin{aligned} & \underset{N}{N} \\ & \stackrel{O}{\mathbf{O}} \end{aligned}$ | $$ | - | Data ${ }^{\text {b }}$ |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| $\begin{aligned} & \text { 이 } \\ & \text { 흐 } \\ & \hline \text { O } \end{aligned}$ |  | 0 | 0 | ACT | 0 | 0 | 1 | 1 | 0 | 0 | 00 | 0 | 0 | 0 | 0 | - |
|  |  |  | 1,2 | D, D | 1 | 0 | 0 | 0 | 0 | 0 | 00 | 0 | 0 | 0 | 0 | - |
|  |  |  | 3,4 | $\overline{\mathrm{D}}, \overline{\mathrm{D}}$ | 1 | 1 | 1 | 1 | 0 | 0 | 00 | 0 | 0 | 0 | 0 | - |
|  |  |  | ... | repeat pattern 1... 4 until $\mathrm{nRCD}-1$, truncate if necessary |  |  |  |  |  |  |  |  |  |  |  |  |
|  |  |  | nRCD | RD | 0 | 1 | 0 | 1 | 0 | 0 | 00 | 0 | 0 | 0 | 0 | 00000000 |
|  |  |  | ... | repeat pattern 1... 4 until nRAS - 1, truncate if necessary |  |  |  |  |  |  |  |  |  |  |  |  |
|  |  |  | nRAS | PRE | 0 | 0 | 1 | 0 | 0 | 0 | 00 | 0 | 0 | 0 | 0 | - |
|  |  |  | $\ldots$ | repeat pattern 1... 4 until nRC - 1, truncate if necessary |  |  |  |  |  |  |  |  |  |  |  |  |
|  |  |  | $1 * n R C+0$ | ACT | 0 | 0 | 1 | 1 | 0 | 0 | 00 | 0 | 0 | F | 0 | - |
|  |  |  | 1*nRC+1,2 | D, D | 1 | 0 | 0 | 0 | 0 | 0 | 00 | 0 | 0 | F | 0 | - |
|  |  |  | 1*nRC+3,4 | $\overline{\mathrm{D}}, \overline{\mathrm{D}}$ | 1 | 1 | 1 | 1 | 0 | 0 | 00 | 0 | 0 | F | 0 | - |
|  |  |  | $\ldots$ | repeat pattern $\mathrm{nRC}+1, \ldots 4$ until $\mathrm{nRC}+\mathrm{nRCE}-1$, truncate if necessary |  |  |  |  |  |  |  |  |  |  |  |  |
|  |  |  | $1 * n R C+n R C D$ | RD | 0 | 1 | 0 | 1 | 0 | 0 | 00 | 0 | 0 | F | 0 | 00110011 |
|  |  |  | $\ldots$ | repeat pattern $n R C+1, \ldots 4$ until nRC + nRAS - 1, truncate if necessary |  |  |  |  |  |  |  |  |  |  |  |  |
|  |  |  | $1 * n R C+n R A S$ | PRE | 0 | 0 | 1 | 0 | 0 | 0 | 00 | 0 | 0 | F | 0 | - |
|  |  |  | $\ldots$ | repeat pattern $\mathrm{nRC}+1, \ldots 4$ until $* 2 \mathrm{nRC}-1$, truncate if necessary |  |  |  |  |  |  |  |  |  |  |  |  |
|  |  | 1 | 2*nRC | repeat Sub-Loop 0, use BA[2:0] = 1 instead |  |  |  |  |  |  |  |  |  |  |  |  |
|  |  | 2 | 4*nRC | repeat Sub-Loop 0, use BA[2:0] $=2$ instead |  |  |  |  |  |  |  |  |  |  |  |  |
|  |  | 3 | 6*nRC | repeat Sub-Loop 0, use BA[2:0] $=3$ instead |  |  |  |  |  |  |  |  |  |  |  |  |
|  |  | 4 | 8*nRC | repeat Sub-Loop 0, use BA[2:0] $=4$ instead |  |  |  |  |  |  |  |  |  |  |  |  |
|  |  | 5 | 10*nRC | repeat Sub-Loop 0, use BA[2:0] $=5$ instead |  |  |  |  |  |  |  |  |  |  |  |  |
|  |  | 6 | 12*nRC | repeat Sub-Loop 0, use BA[2:0] = 6 instead |  |  |  |  |  |  |  |  |  |  |  |  |
|  |  | 7 | $14 * n R C$ | repeat Sub-Loop 0, use BA[2:0] = 7 instead |  |  |  |  |  |  |  |  |  |  |  |  |

a) DM must be driven LOW all the time. DQS, $\overline{\text { DQS }}$ are used according to RD Commands, otherwise MID-LEVEL.
b) Burst Sequence driven on each DQ signal by Read Command. Outside burst operation, DQ signals are MID_LEVEL.

## Иทиіх

## Table 5 －IDD2N and IDD3N Measurement－Loop Pattern ${ }^{\text {a）}}$

| ַ | $\underset{\mathbf{v}}{\mathbf{v}}$ | $\begin{aligned} & \text { 응 } \\ & 0 \\ & \frac{1}{5} \\ & \text { un } \end{aligned}$ |  |  | 10 | $1 \stackrel{9}{\square}$ | lư | $1 \underset{3}{\omega}$ | $\stackrel{5}{0}$ | $\begin{aligned} & \underset{\sim}{\underset{\sim}{N}} \\ & \underset{\sim}{\mathbf{N}} \end{aligned}$ | $\begin{aligned} & \text { 글 } \\ & \text { ヘ̈ } \\ & \stackrel{\rightharpoonup}{4} \end{aligned}$ | 家 | $\begin{aligned} & \text { ה゙ } \\ & \text { ö } \end{aligned}$ | $\begin{aligned} & \boldsymbol{M} \\ & \stackrel{0}{4} \\ & \hline \mathbf{4} \end{aligned}$ | $\begin{aligned} & \underset{\sim}{N} \\ & \underset{\sim}{4} \end{aligned}$ | Data ${ }^{\text {b }}$ |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  | $\begin{aligned} & \text { 두 } \\ & \text { N } \\ & \text { U } \\ & \text { © } \end{aligned}$ | 0 | 0 | D | 1 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | － |
|  |  |  | 1 | D | 1 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | － |
|  |  |  | 2 | $\overline{\mathrm{D}}$ | 1 | 1 | 1 | 1 | 0 | 0 | 0 | 0 | 0 | F | 0 | － |
|  |  |  | 3 | $\overline{\mathrm{D}}$ | 1 | 1 | 1 | 1 | 0 | 0 | 0 | 0 | 0 | F | 0 | － |
|  |  | 1 | 4－7 | repeat Sub－Loop 0，use BA［2：0］＝ 1 instead |  |  |  |  |  |  |  |  |  |  |  |  |
|  |  | 2 | 8－11 | repeat Sub－Loop 0，use BA［2：0］$=2$ instead |  |  |  |  |  |  |  |  |  |  |  |  |
|  |  | 3 | 12－15 | repeat Sub－Loop 0，use BA［2：0］$=3$ instead |  |  |  |  |  |  |  |  |  |  |  |  |
|  |  | 4 | 16－19 | repeat Sub－Loop 0，use BA［2：0］$=4$ instead |  |  |  |  |  |  |  |  |  |  |  |  |
|  |  | 5 | 20－23 | repeat Sub－Loop 0，use BA［2：0］＝ 5 instead |  |  |  |  |  |  |  |  |  |  |  |  |
|  |  | 6 | 24－17 | repeat Sub－Loop 0，use BA［2：0］$=6$ instead |  |  |  |  |  |  |  |  |  |  |  |  |
|  |  | 7 | 28－31 | repeat Sub－Loop 0，use BA［2：0］＝ 7 instead |  |  |  |  |  |  |  |  |  |  |  |  |

a）DM must be driven LOW all the time．DQS，$\overline{\mathrm{DQS}}$ are MID－LEVEL．
b）DQ signals are MID－LEVEL．
Table 6 －IDD2NT and IDDQ2NT Measurement－Loop Pattern ${ }^{\text {a）}}$

| \|Y | $\underset{\underset{U}{\mathbf{~}}}{ }$ |  | $\frac{\frac{1}{\bar{o}}}{\frac{0}{0}} \frac{1}{5}$ | 증 © E E 0 | 10 | $\mid \underset{4}{9}$ | \|y | $1 \mathbf{3}$ | $\stackrel{1}{6}$ |  | $\begin{aligned} & \text { 글 } \\ & \text { ï } \\ & \stackrel{\rightharpoonup}{4} \end{aligned}$ | $\stackrel{\text { 울 }}{\stackrel{-1}{4}}$ | $\begin{aligned} & \text { N } \\ & \text { öl } \end{aligned}$ | $\begin{aligned} & \underset{\sim}{\ddot{0}} \\ & \underset{4}{6} \end{aligned}$ | $\begin{aligned} & \underset{\sim}{\dot{N}} \\ & \text { ' } \end{aligned}$ | Data ${ }^{\text {b }}$ |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| $\begin{aligned} & \text { 을 } \\ & \text { 이 } \\ & \hline \mathbf{O} \end{aligned}$ |  | 0 | 0 | D | 1 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | － |
|  |  |  | 1 | D | 1 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | － |
|  |  |  | 2 | $\overline{\mathrm{D}}$ | 1 | 1 | 1 | 1 | 0 | 0 | 0 | 0 | 0 | F | 0 | － |
|  |  |  | 3 | $\overline{\mathrm{D}}$ | 1 | 1 | 1 | 1 | 0 | 0 | 0 | 0 | 0 | F | 0 | － |
|  |  | 1 | 4－7 | repeat Sub－Loop 0，but ODT $=0$ and $\mathrm{BA}[2: 0]=1$ |  |  |  |  |  |  |  |  |  |  |  |  |
|  |  | 2 | 8－11 | repeat Sub－Loop 0，but ODT $=1$ and $\mathrm{BA}[2: 0]=2$ |  |  |  |  |  |  |  |  |  |  |  |  |
|  |  | 3 | 12－15 | repeat Sub－Loop 0，but ODT $=1$ and $\mathrm{BA}[2: 0]=3$ |  |  |  |  |  |  |  |  |  |  |  |  |
|  |  | 4 | 16－19 | repeat Sub－Loop 0，but ODT $=0$ and $\mathrm{BA}[2: 0]=4$ |  |  |  |  |  |  |  |  |  |  |  |  |
|  |  | 5 | 20－23 | repeat Sub－Loop 0，but ODT $=0$ and $\mathrm{BA}[2: 0]=5$ |  |  |  |  |  |  |  |  |  |  |  |  |
|  |  | 6 | 24－17 | repeat Sub－Loop 0，but ODT $=1$ and $\mathrm{BA}[2: 0]=6$ |  |  |  |  |  |  |  |  |  |  |  |  |
|  |  | 7 | 28－31 | repeat Sub－Loop 0，but ODT $=1$ and $\mathrm{BA}[2: 0]=7$ |  |  |  |  |  |  |  |  |  |  |  |  |

a）DM must be driven LOW all the time．DQS，$\overline{\mathrm{DQS}}$ are MID－LEVEL．
b）DQ signals are MID－LEVEL．

## Иทиіх

## Table 7 - IDD4R and IDDQ24RMeasurement-Loop Pattern ${ }^{\text {a) }}$

| \|Y | $\underset{\sim}{\ddot{V}}$ |  |  | ס © In E 0 | IU | $\left\lvert\, \begin{aligned} & \square \\ & \boxed{y} \end{aligned}\right.$ | lun | $\mid \underset{3}{3}$ | $\stackrel{5}{0}$ |  | $\begin{aligned} & \text { 급 } \\ & \text { 불 } \\ & \stackrel{\rightharpoonup}{4} \end{aligned}$ | $\begin{aligned} & \mathbf{o} \\ & \stackrel{-1}{4} \\ & \hline \end{aligned}$ | $\begin{aligned} & \text { N } \\ & \text { ö } \end{aligned}$ | $\begin{aligned} & \boldsymbol{n} \\ & \stackrel{0}{\mathbf{Q}} \end{aligned}$ | ? | Data ${ }^{\text {b }}$ |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  | 0 | 0 | RD | 0 | 1 | 0 | 1 | 0 | 0 | 00 | 0 | 0 | 0 | 0 | 00000000 |
|  |  |  | 1 | D | 1 | 0 | 0 | 0 | 0 | 0 | 00 | 0 | 0 | 0 | 0 | - |
|  |  |  | 2,3 | $\overline{\mathrm{D}}, \overline{\mathrm{D}}$ | 1 | 1 | 1 | 1 | 0 | 0 | 00 | 0 | 0 | 0 | 0 | - |
|  |  |  | 4 | RD | 0 | 1 | 0 | 1 | 0 | 0 | 00 | 0 | 0 | F | 0 | 00110011 |
|  |  |  | 5 | D | 1 | 0 | 0 | 0 | 0 | 0 | 00 | 0 | 0 | F | 0 | - |
|  |  |  | 6,7 | $\overline{\mathrm{D}}, \overline{\mathrm{D}}$ | 1 | 1 | 1 | 1 | 0 | 0 | 00 | 0 | 0 | F | 0 | - |
|  |  | 1 | 8-15 | repeat Sub-Loop 0, but BA[2:0] = 1 |  |  |  |  |  |  |  |  |  |  |  |  |
|  |  | 2 | 16-23 | repeat Sub-Loop 0, but BA[2:0] = 2 |  |  |  |  |  |  |  |  |  |  |  |  |
|  |  | 3 | 24-31 | repeat Sub-Loop 0, but BA[2:0] = 3 |  |  |  |  |  |  |  |  |  |  |  |  |
|  |  | 4 | 32-39 | repeat Sub-Loop 0, but BA[2:0] $=4$ |  |  |  |  |  |  |  |  |  |  |  |  |
|  |  | 5 | 40-47 | repeat Sub-Loop 0, but BA[2:0] = 5 |  |  |  |  |  |  |  |  |  |  |  |  |
|  |  | 6 | 48-55 | repeat Sub-Loop 0, but BA[2:0] $=6$ |  |  |  |  |  |  |  |  |  |  |  |  |
|  |  | 7 | 56-63 | repeat Sub-Loop 0, but BA[2:0] = 7 |  |  |  |  |  |  |  |  |  |  |  |  |

a) DM must be driven LOW all the time. DQS, $\overline{\mathrm{DQS}}$ are used according to RD Commands, otherwise MID-LEVEL.
b) Burst Sequence driven on each DQ signal by Read Command. Outside burst operation, DQ signals are MID-LEVEL.

## Иทиіх

## Table 8 －I DD4W Measurement－Loop Pattern ${ }^{\text {a）}}$

| $\begin{aligned} & \underline{U} \\ & \underline{U} \end{aligned}$ | $\underset{\mathbf{V}}{\underset{\sim}{4}}$ | $\begin{aligned} & \text { 응 } \\ & 0 \\ & \frac{1}{3} \\ & \dot{1} \end{aligned}$ |  | ס © © E 0 0 | 10 | $1 \stackrel{y}{〔}$ | $\left.\right\|_{\boxed{8}} ^{\Omega}$ | $1 \stackrel{\omega}{3}$ | $\stackrel{5}{0}$ | $\begin{aligned} & \boldsymbol{O} \\ & \stackrel{0}{N} \\ & \underset{\mathbf{N}}{\mathbf{N}} \end{aligned}$ | $\begin{aligned} & \underset{\sim}{7} \\ & \stackrel{\rightharpoonup}{\hat{C}} \\ & \underset{4}{4} \end{aligned}$ | $\begin{aligned} & \text { 울 } \\ & \stackrel{-1}{4} \end{aligned}$ | $\begin{aligned} & \text { הi } \\ & \text { Ö } \end{aligned}$ | $\begin{gathered} ⿳ 亠 丷 厂 犬 \\ \stackrel{0}{4} \end{gathered}$ | $\begin{aligned} & \underset{\sim}{\dot{N}} \\ & \text { ' } \end{aligned}$ | Data ${ }^{\text {b）}}$ |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  | 0 | 0 | WR | 0 | 1 | 0 | 0 | 1 | 0 | 00 | 0 | 0 | 0 | 0 | 00000000 |
|  |  |  | 1 | D | 1 | 0 | 0 | 0 | 1 | 0 | 00 | 0 | 0 | 0 | 0 | － |
|  |  |  | 2，3 | $\overline{\mathrm{D}}, \overline{\mathrm{D}}$ | 1 | 1 | 1 | 1 | 1 | 0 | 00 | 0 | 0 | 0 | 0 | － |
|  |  |  | 4 | WR | 0 | 1 | 0 | 0 | 1 | 0 | 00 | 0 | 0 | F | 0 | 00110011 |
|  |  |  | 5 | D | 1 | 0 | 0 | 0 | 1 | 0 | 00 | 0 | 0 | F | 0 | － |
|  |  |  | 6，7 | $\overline{\mathrm{D}}, \overline{\mathrm{D}}$ | 1 | 1 | 1 | 1 | 1 | 0 | 00 | 0 | 0 | F | 0 | － |
|  |  | 1 | 8－15 | repeat Sub－Loop 0，but BA［2：0］＝ 1 |  |  |  |  |  |  |  |  |  |  |  |  |
|  |  | 2 | 16－23 | repeat Sub－Loop 0，but BA［2：0］＝ 2 |  |  |  |  |  |  |  |  |  |  |  |  |
|  |  | 3 | 24－31 | repeat Sub－Loop 0，but BA［2：0］＝ 3 |  |  |  |  |  |  |  |  |  |  |  |  |
|  |  | 4 | 32－39 | repeat Sub－Loop 0，but BA［2：0］＝ 4 |  |  |  |  |  |  |  |  |  |  |  |  |
|  |  | 5 | 40－47 | repeat Sub－Loop 0，but BA［2：0］＝5 |  |  |  |  |  |  |  |  |  |  |  |  |
|  |  | 6 | 48－55 | repeat Sub－Loop 0，but BA［2：0］$=6$ |  |  |  |  |  |  |  |  |  |  |  |  |
|  |  | 7 | 56－63 | repeat Sub－Loop 0，but BA［2：0］＝ 7 |  |  |  |  |  |  |  |  |  |  |  |  |

a）DM must be driven LOW all the time．DQS，$\overline{\mathrm{DQS}}$ are used according to WR Commands，otherwise MID－LEVEL．
b）Burst Sequence driven on each DQ signal by Write Command．Outside burst operation，DQ signals are MID－LEVEL．

## Table 9 －I DD5B Measurement－Loop Pattern ${ }^{\text {a）}}$

| \|ソ | $\underset{\text { யு }}{\mathbf{U}}$ | $\begin{aligned} & 0 \\ & 0.0 \\ & 1 \\ & \text { 을 } \end{aligned}$ | $\frac{0}{4} \frac{\frac{1}{y}}{\vdots}$ |  | 10 | $\mid \stackrel{u}{c}$ | $1 \frac{0}{8}$ | $1 \mathbf{3}$ | $\stackrel{1}{0}$ | $\begin{gathered} \underset{\sim}{\dot{N}} \\ \underset{\sim}{\mathbf{N}} \end{gathered}$ | $\begin{aligned} & \text { 글 } \\ & \stackrel{\rightharpoonup}{n} \\ & \stackrel{\rightharpoonup}{4} \end{aligned}$ | $\begin{aligned} & \text { 울 } \\ & \stackrel{1}{4} \end{aligned}$ |  | $$ | O N N | Data ${ }^{\text {b }}$ |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| $\begin{aligned} & \text { 응 } \\ & \text { 흥 } \\ & \hline 0 \end{aligned}$ |  | 0 | 0 | REF | 0 | 0 | 0 | 1 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | － |
|  |  | 1 | 1.2 | D，D | 1 | 0 | 0 | 0 | 0 | 0 | 00 | 0 | 0 | 0 | 0 | － |
|  |  |  | 3，4 | $\overline{\mathrm{D}}, \overline{\mathrm{D}}$ | 1 | 1 | 1 | 1 | 0 | 0 | 00 | 0 | 0 | F | 0 | － |
|  |  |  | 5．．． 8 | repeat cycles 1．．．4，but BA［2：0］＝ 1 |  |  |  |  |  |  |  |  |  |  |  |  |
|  |  |  | 9．．． 12 | repeat cycles $1 . .4$ ，but BA［2：0］$=2$ |  |  |  |  |  |  |  |  |  |  |  |  |
|  |  |  | 13．．． 16 | repeat cycles $1 . . .4$ ，but $\mathrm{BA}[2: 0]=3$ |  |  |  |  |  |  |  |  |  |  |  |  |
|  |  |  | 17．．． 20 | repeat cycles $1 . .4$ ，but $\mathrm{BA}[2: 0]=4$ |  |  |  |  |  |  |  |  |  |  |  |  |
|  |  |  | 21．．． 24 | repeat cycles $1 . . .4$ ，but $\mathrm{BA}[2: 0]=5$ |  |  |  |  |  |  |  |  |  |  |  |  |
|  |  |  | 25．．． 28 | repeat cycles $1 . .4$ ，but $\mathrm{BA}[2: 0]=6$ |  |  |  |  |  |  |  |  |  |  |  |  |
|  |  |  | 29．．． 32 | repeat cycles $1 . . .4$ ，but BA［2：0］$=7$ |  |  |  |  |  |  |  |  |  |  |  |  |
|  |  | 2 | 33．．．nRFC－1 | repeat Sub－Loop 1，until nRFC－1．Truncate，if necessary． |  |  |  |  |  |  |  |  |  |  |  |  |

a）DM must be driven LOW all the time．DQS，$\overline{\mathrm{DQS}}$ are MID－LEVEL．
b）DQ signals are MID－LEVEL．

## Иทиіх

## Table 10－IDD7 Measurement－Loop Pattern ${ }^{\text {a）}}$

ATTENTION！Sub－Loops 10－19 have inverse A［6：3］Pattern and Data Pattern than Sub－Loops 0－9

| \|ソ | $\underset{\sim}{\boldsymbol{V}}$ | $\begin{aligned} & \text { 응 } \\ & 0 \\ & \frac{1}{3} \\ & \dot{n} \end{aligned}$ |  | $\begin{aligned} & \text { 을 } \\ & \text { 0 } \\ & \text { E } \\ & 0 \\ & 0 \end{aligned}$ | 10 | $1 \begin{aligned} & \square \\ & \boxed{c} \end{aligned}$ | lus | $\mid$ |  | $\stackrel{\bullet}{\circ}$ | $\begin{aligned} & \stackrel{O}{N} \\ & \stackrel{N}{\mathbf{N}} \end{aligned}$ | $\begin{aligned} & \text { 글 } \\ & \text { ベ̈ } \\ & \text { 岂 } \end{aligned}$ | $\begin{aligned} & \mathbf{0} \\ & \underset{子}{4} \\ & \text { N } \end{aligned}$ | $\begin{aligned} & \text { N } \\ & \text { O} \\ & \mathbf{4} \end{aligned}$ | $\begin{aligned} & \underset{M}{\ddot{0}} \\ & \stackrel{0}{4} \end{aligned}$ | O | Data ${ }^{\text {b }}$ |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  | 0 |  | 0 | ACT | 0 | 0 | 1 | 1 |  | 0 | 0 | 00 | 0 | 0 | 0 | 0 | － |
|  |  |  | 1 | RDA | 0 | 1 | 0 | 1 |  | 0 | 0 | 00 | 1 | 0 | 0 | 0 | 00000000 |
|  |  |  | 2 | D | 1 | 0 | 0 | 0 |  | 0 | 0 | 00 | 0 | 0 | 0 | 0 | － |
|  |  |  | ．．． | repeat above D Command until nRRD－ 1 |  |  |  |  |  |  |  |  |  |  |  |  |  |
|  |  |  | nRRD | ACT | 0 | 0 | 1 | 1 |  | 0 | 1 | 00 | 0 | 0 | F | 0 | － |
|  |  | 1 | nRRD＋1 | RDA | 0 | 1 | 0 | 1 |  | 0 | 1 | 00 | 1 | 0 | F | 0 | 00110011 |
|  |  | 1 | nRRD＋2 | D | 1 | 0 | 0 | 0 |  | 0 | 1 | 00 | 0 | 0 | F | 0 | － |
|  |  |  | ．．． | repeat above D Command until 2＊nRRD－ 1 |  |  |  |  |  |  |  |  |  |  |  |  |  |
|  |  | 2 | 2＊nRRD | repeat Sub－Loop 0，but BA［2：0］＝ 2 |  |  |  |  |  |  |  |  |  |  |  |  |  |
|  |  | 3 | 3＊nRRD | repeat Sub－Loop 1，but BA［2：0］＝ 3 |  |  |  |  |  |  |  |  |  |  |  |  |  |
|  |  | 4 | $4 *$ RRRD | D | 1 | 0 | 0 | 0 |  | 0 | 3 | 00 | 0 | 0 | F | 0 | － |
|  |  |  |  | Assert and repeat above D Command until nFAW－1，if necessary |  |  |  |  |  |  |  |  |  |  |  |  |  |
|  |  | 5 | nFAW | repeat Sub－Loop 0，but BA［2：0］$=4$ |  |  |  |  |  |  |  |  |  |  |  |  |  |
|  |  | 6 | nFAW＋nRRD | repeat Sub－Loop 1，but BA［2：0］＝ 5 |  |  |  |  |  |  |  |  |  |  |  |  |  |
|  |  | 7 | nFAW＋2＊nRRD | repeat Sub－Loop 0，but BA［2：0］$=6$ |  |  |  |  |  |  |  |  |  |  |  |  |  |
|  |  | 8 | nFAW＋3＊nRRD | repeat Sub－Loop 1，but BA［2：0］＝ 7 |  |  |  |  |  |  |  |  |  |  |  |  |  |
|  |  | 9 | nFAW＋4＊nRRD | D | 1 | 0 | 0 | 0 |  | 0 | 7 | 00 | 0 | 0 | F | 0 | － |
|  |  | 9 |  | Assert and repeat above D Command until 2＊nFAW－1，if necessary |  |  |  |  |  |  |  |  |  |  |  |  |  |
|  |  |  | 2＊nFAW＋0 | ACT | 0 | 0 | 1 | 1 |  | 0 | 0 | 00 | 0 | 0 | F | 0 | － |
|  |  | 10 | 2＊nFAW＋1 | RDA | 0 | 1 | 0 | 1 |  | 0 | 0 | 00 | 1 | 0 | F | 0 | 00110011 |
|  |  | 10 |  | D | 1 | 0 | 0 | 0 |  | 0 | 0 | 00 | 0 | 0 | F | 0 | － |
|  |  |  | 2\＆nFAW＋2 | Repeat above D Command until $2^{*}$ nFAW＋nRRD－ 1 |  |  |  |  |  |  |  |  |  |  |  |  |  |
|  |  |  | 2＊nFAW＋nRRD | ACT | 0 | 0 | 1 | 1 |  | 0 | 1 | 00 | 0 | 0 | 0 | 0 | － |
|  |  | 11 | 2＊nFAW＋nRRD＋1 | RDA | 0 | 1 | 0 | 1 |  | 0 | 1 | 00 | 1 | 0 | 0 | 0 | 00000000 |
|  |  | 11 | 2\＆nFAW＋nRRD＋ | D | 1 | 0 | 0 | 0 |  | 0 | 1 | 00 | 0 | 0 | 0 | 0 | － |
|  |  |  |  | Repeat above D Command until 2＊nFAW＋2＊nRRD－1 |  |  |  |  |  |  |  |  |  |  |  |  |  |
|  |  | 12 | 2＊nFAW＋2＊nRRD | repeat Sub－Loop 10，but BA［2：0］＝ 2 |  |  |  |  |  |  |  |  |  |  |  |  |  |
|  |  | 13 | 2＊nFAW＋3＊nRRD | repeat Sub－Loop 11，but BA［2：0］$=3$ |  |  |  |  |  |  |  |  |  |  |  |  |  |
|  |  | 14 | 2＊nFAW＋4＊nRRD | D | 1 | 0 | 0 | 0 |  | 0 | 3 | 00 | 0 | 0 | 0 | 0 | － |
|  |  |  |  | Assert and repeat above D Command until 3＊nFAW－1，if necessary |  |  |  |  |  |  |  |  |  |  |  |  |  |
|  |  | 15 | 3＊nFAW | repeat Sub－Loop 10，but BA［2：0］＝ 4 |  |  |  |  |  |  |  |  |  |  |  |  |  |
|  |  | 16 | 3＊ $\mathrm{nFAW}+\mathrm{nRRD}$ | repeat Sub－Loop 11，but BA［2：0］＝ 5 |  |  |  |  |  |  |  |  |  |  |  |  |  |
|  |  | 17 | 3＊nFAW＋2＊nRRD | repeat Sub－Loop 10，but BA［2：0］＝ 6 |  |  |  |  |  |  |  |  |  |  |  |  |  |
|  |  | 18 | $3{ }^{*} \mathrm{nFAW}+3 * n R R D$ | repeat Sub－Loop 11，but BA［2：0］$=7$ |  |  |  |  |  |  |  |  |  |  |  |  |  |
|  |  | 19 | $3 * n F A W+4 * n R R D$ | D | 1 | 0 | 0 | 0 |  | 0 | 7 | 00 | 0 | 0 | 0 | 0 | － |
|  |  |  |  | Assert and repeat above D Command until 4＊nFAW－1，if necessary |  |  |  |  |  |  |  |  |  |  |  |  |  |

a）DM must be driven LOW all the time．DQS，$\overline{\mathrm{DQS}}$ are used according to RD Commands，otherwise MID－LEVEL．
b）Burst Sequence driven on each DQ signal by Read Command．Outside burst operation，DQ signals are MID－LEVEL．

## Иทиіх

## IDD Specifications

IDD values are for full operating range of voltage and temperature unless otherwise noted.

## /DD Specification

| Speed Grade Bin | $\begin{gathered} \text { DDR3L - } 1066 \\ 7-7-7 \end{gathered}$ | $\begin{gathered} \text { DDR3L - } 1333 \\ 9-9-9 \end{gathered}$ | Unit | Notes |
| :---: | :---: | :---: | :---: | :---: |
| Symbol | Max. | Max. |  |  |
| / DD0 | 68 | 70 | mA | x4/x8 |
| /DD01 | 78 | 80 | mA |  |
| / DD2P0 | 9 | 9 | mA |  |
| /DD2P1 | 25 | 28 | mA |  |
| /DD2N | 40 | 44 | mA |  |
| / DD2NT | 42 | 45 | mA |  |
| IDD2Q | 40 | 44 | mA |  |
| / DD3P | 28 | 30 | mA |  |
| IDD3N | 50 | 52 | mA |  |
| / DD4R | 130 | 140 | mA |  |
| / DD4W | 135 | 145 | mA |  |
| / DD5B | 210 | 210 | mA |  |
| / DD6 | 9 | 9 | mA | x4/x8,1 |
| / DD6ET | 12 | 12 | mA | x4/x8,2 |
| / DD6TC | 12 | 12 | mA | x4/x8,3 |
| / DD7 | 190 | 210 | mA | x4/x8 |

## Notes:

1. Applicable for MR2 settings $A 6=0$ and $A 7=0$. Temperature range for IDD6 is $0-85^{\circ} \mathrm{C}$.
2. Applicable for MR 2 settings $\mathrm{A} 6=0$ and $\mathrm{A} 7=1$. Temperature range for IDD6ET is $0-95^{\circ} \mathrm{C}$.
3. Applicable for MR2 settings $\mathrm{A} 6=1$ and $\mathrm{A} 7=0$. IDD6TC is measured at $95^{\circ} \mathrm{C}$

## Иทиіх

## I nput/ Output Capacitance

| Parameter | Symbol | DDR3L-800 |  | DDR3L-1066 |  | DDR3L-1333 |  | Units | Notes |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  | Min | Max | Min | Max | Min | Max |  |  |
| Input/output capacitance (DQ, DM, DQS, $\overline{D Q S}$, TDQS, TDQS) | $\mathrm{ClO}_{10}$ | 1.5 | 2.5 | 1.5 | 2.5 | 1.5 | 2.3 | pF | 1,2,3 |
| Input capacitance, CK and $\overline{\mathrm{CK}}$ | $\mathrm{C}_{\mathrm{CK}}$ | 0.8 | 1.6 | 0.8 | 1.6 | 0.8 | 1.4 | pF | 2,3 |
| Input capacitance delta CK and $\overline{\mathrm{CK}}$ | $\mathrm{C}_{\text {DCK }}$ | 0 | 0.15 | 0 | 0.15 | 0 | 0.15 | pF | 2,3,4 |
| Input capacitance delta, DQS and DQS | $C_{\text {DDQS }}$ | 0 | 0.20 | 0 | 0.20 | 0 | 0.15 | pF | 2,3,5 |
| Input capacitance <br> (All other input-only pins) | $C_{1}$ | 0.75 | 1.3 | 0.75 | 1.3 | 0.75 | 1.3 | pF | 2,3,6 |
| Input capacitance delta (All CTRL input-only pins) | $\mathrm{C}_{\text {DI_CTRL }}$ | -0.5 | 0.3 | -0.5 | 0.3 | -0.4 | 0.2 | pF | 2,3,7,8 |
| Input capacitance delta (All ADD/CMD input-only pins) | $\mathrm{C}_{\mathrm{DI} \text { MDD_C }}$ | -0.5 | 0.5 | -0.5 | 0.5 | -0.4 | 0.4 | pF | 2,3,9,10 |
| Input/output capacitance delta $\text { (DQ, DM, DQS, } \overline{\mathrm{DQS}})$ | $\mathrm{C}_{\text {DIO }}$ | -0.5 | 0.3 | -0.5 | 0.3 | -0.5 | 0.3 | pF | 2,3,11 |
| Input/output capacitance of ZQ pin | $\mathrm{C}_{\mathrm{ZQ}}$ | - | 3 | - | 3 | - | 3 | pF | 2,3,12 |

## Notes:

1. Although the DM, TDQS and $\overline{T D Q S}$ pins have different functions, the loading matches DQ and DQS.
2. This parameter is not subject to production test. It is verified by design and characterization. The capacitance is measured according to JEP147("PROCEDURE FOR MEASURING INPUT CAPACITANCE USING A VECTOR NETWORK ANALYZER(VNA)") with VDD, VDDQ, VSS,VSSQ applied and all other pins floating (except the pin under test, CKE, $\overline{\mathrm{RESET}}$ and ODT as necessary). $\mathrm{VDD}=\mathrm{VDDQ}=1.5 \mathrm{~V}\left(\mathrm{cf} . \mathrm{C}_{10} \& \mathrm{C}_{1}=1.35 \mathrm{~V}\right)$, $\mathrm{VBIAS}=\mathrm{VDD} / 2$ and on-die termination off.
3. This parameter applies to monolithic devices only; stacked/dual-die devices are not covered here
4. Absolute value of $\mathrm{C}_{\mathrm{CK}}-\mathrm{C}_{\overline{\mathrm{CK}}}$.
5. Absolute value of $\mathrm{C}_{10}(\mathrm{DQS})-\mathrm{C}_{10}(\overline{\mathrm{DQS}})$.
6. $C_{1}$ applies to ODT, $\overline{C S}, C K E, A 0-A 15, B A 0-B A 2, \overline{R A S}, \overline{C A S}, \overline{W E}$.
7. $\mathrm{C}_{\text {DI_CTR }}$ applies to ODT, $\overline{\mathrm{CS}}$ and CKE.
8. $\left.C_{D I_{-} C T R L}=C_{I}(C N T L)-0.5 * C_{1}(C L K)+C_{I}(\overline{C L K})\right)$
9. $C_{D I \_A D D}$ CMD applies to AO-A15, BAO-BA2, $\overline{\mathrm{RAS}}, \overline{\mathrm{CAS}}$ and $\overline{\mathrm{WE}}$.
10. $C_{D I_{-} A D D \_C M D}=C_{1}\left(A D D_{-} C M D\right)-0.5 *\left(C_{1}(C L K)+C_{1}(\overline{C L K})\right)$
11. $C_{D I O}=C_{10}(D Q)-0.5^{*}\left(C_{10}(D Q S)+C_{10}(\overline{D Q S})\right)$
12. Maximum external load capacitance an ZQ pin: 5 pF .

## Иทиіх

## Standard Speed Bins

DDR3L SDRAM Standard Speed Bins include tCK, tRCD, tRP, tRAS and tRC for each corresponding bin.

## DDR3L-800 Speed Bins

## For specific Notes See "Speed Bin Table Notes" on page 30.

| Speed Bin |  |  | DDR3-800E |  | Unit | Notes |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| CL-nRCD - nRP |  |  | 6-6-6 |  |  |  |
|  |  | Symbol | min | max |  |  |
| Internal read command to first data |  | $t_{\text {AA }}$ | 15 | 20 | ns |  |
| ACT to internal read or write delay time |  | $t_{\text {RCD }}$ | 15 | - | ns |  |
| PRE command period |  | $t_{\text {RP }}$ | 15 | - | ns |  |
| ACT to ACT or REF command period |  | $t_{\text {RC }}$ | 52.5 | - | ns |  |
| ACT to PRE command period |  | $t_{\text {RAS }}$ | 37.5 | 9 * tREFI | ns |  |
| $C L=5$ | CWL $=5$ | $t_{\text {CK(AVG) }}$ | Reserved |  | ns | 1, 2, 3, 4 |
| $C L=6$ | CWL $=5$ | $t_{\text {CK(AVG) }}$ | 2.5 | 3.3 | ns | 1, 2, 3 |
| Supported CL Settings |  |  | 6 |  | $n_{\text {CK }}$ |  |
| Supported CWL Settings |  |  | 5 |  | $n_{\text {CK }}$ |  |

## Ициіх

## DDR3-1066 Speed Bins

For specific Notes See "Speed Bin Table Notes" on page 30.

| Speed Bin |  |  | DDR3-1066F |  | Unit | Note |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| CL - nRCD - nRP |  |  | 7-7-7 |  |  |  |
|  | meter | Symbol | min | max |  |  |
| Internal read command to first data |  | $t_{\text {AA }}$ | 13.125 | 20 | ns |  |
| ACT to internal read or write delay time |  | $t_{\text {RCD }}$ | 13.125 | - | ns |  |
| PRE command period |  | $t_{\text {RP }}$ | 13.125 | - | ns |  |
| ACT to ACT or REF command period |  | $t_{\text {RC }}$ | 50.625 | - | ns |  |
| ACT to PRE command period |  | $t_{\text {RAS }}$ | 37.5 | 9 * tREFI | ns |  |
| $C L=5$ | CWL $=5$ | $t_{\text {CK(AVG })}$ | Reserved |  | ns | 1, 2, 3, 4, 5 |
|  | CWL $=6$ | $t_{\text {CK(AVG })}$ | Reserved |  | ns | 4 |
| $C L=6$ | CWL $=5$ | $t_{\text {CK(AVG })}$ | 2.5 | 3.3 | ns | 1, 2, 3, 5 |
|  | CWL $=6$ | $t_{\text {CK(AVG })}$ | Reserved |  | ns | 1, 2, 3, 4 |
| $C L=7$ | CWL = 5 | $t_{\text {CK(AVG) }}$ | Reserved |  | ns | 4 |
|  | $C W L=6$ | $t_{\text {CK(AVG })}$ | 1.875 | $<2.5$ | ns | 1, 2, 3, 4 |
| $\mathrm{CL}=8$ | CWL $=5$ | $t_{\text {CK(AVG })}$ | Reserved |  | ns | 4 |
|  | CWL = 6 | $t_{\text {CK(AVG })}$ | 1.875 | $<2.5$ | ns | 1, 2, 3 |
| Supported CL Settings |  |  | 6, 7, 8 |  | $n_{\text {CK }}$ |  |
| Supported CWL Settings |  |  | 5, 6 |  | $n_{\text {CK }}$ |  |

## Иทиіх

## DDR3-1333 Speed Bins

## For specific Notes See "Speed Bin Table Notes" on page 30.

| Speed Bin |  |  | DDR3-1333H |  | Unit | Note |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| CL - nRCD - nRP |  |  | 9-9-9 |  |  |  |
| Parameter |  | Symbol | min | max |  |  |
| Internal read command to first data |  | $t_{\text {AA }}$ | $\begin{gathered} 13.5 \\ (13.125)^{8} \end{gathered}$ | 20 | ns |  |
| ACT to internal read or write delay time |  | $t_{\text {RCD }}$ | $\begin{gathered} 13.5 \\ (13.125)^{8} \end{gathered}$ | - | ns |  |
| PRE command period |  | $t_{\text {RP }}$ | $\begin{gathered} 13.5 \\ (13.125)^{8} \end{gathered}$ | - | ns |  |
| ACT to ACT or REF command period |  | $t_{\text {RC }}$ | $\begin{gathered} 49.5 \\ (49.125)^{8} \end{gathered}$ | - | ns |  |
| ACT to PRE command period |  | $t_{\text {RAS }}$ | 36 | 9* tREFI | ns |  |
| $C L=5$ | CWL $=5$ | $t_{\text {CK(AVG })}$ | Reserved |  | ns | 1,2, 3,4, 6 |
|  | CWL $=6,7$ | $t_{\text {CK(AVG })}$ | Reserved |  | ns | 4 |
| $C L=6$ | CWL $=5$ | $t_{\text {CK(AVG })}$ | 2.5 | 3.3 | ns | 1, 2, 3, 6 |
|  | CWL = 6 | $t_{\text {CK(AVG })}$ | Reserved |  | ns | 1, 2, 3, 4, 6 |
|  | CWL $=7$ | $t_{\text {CK(AVG })}$ | Reserved |  | ns | 4 |
| $C L=7$ | CWL = 5 | $t_{\text {CK(AVG })}$ | Reserved |  | ns | 4 |
|  | CWL $=6$ | $t_{\text {CK(AVG })}$ | 1.875 | < 2.5 | ns | 1, 2, 3, 4, 6 |
|  |  |  | Reserved |  |  |  |
|  | CWL $=7$ | $t_{\text {CK(AVG }}$ | Reserved |  | ns | 1, 2, 3, 4 |
| $C L=8$ | CWL $=5$ | $t_{\text {CK(AVG })}$ | Reserved |  | ns | 4 |
|  | CWL $=6$ | $t_{\text {CK(AVG })}$ | 1.875 | $<2.5$ | ns | 1, 2, 3, 6 |
|  | CWL $=7$ | $t_{\text {CK(AVG })}$ | Reserved |  | ns | 1, 2, 3, 4 |
| $C L=9$ | CWL = 5, 6 | $t_{\text {CK(AVG })}$ | Reserved |  | ns | 4 |
|  | CWL $=7$ | $t_{\text {CK(AVG })}$ | 1.5 | <1.875 | ns | 1, 2, 3, 4 |
| $C L=10$ | CWL = 5, 6 | $t_{\text {CK(AVG })}$ | Reserved |  | ns | 4 |
|  | $C W L=7$ | $t_{\text {CK(AVG })}$ | 1.5 | <1.875 | ns | 1, 2, 3 |
|  |  |  | Reserved |  | ns |  |
| Supported CL Settings |  |  | 6, 8, (7), 9, (10) |  | $n_{\text {CK }}$ |  |
| Supported CWL Settings |  |  | 5, 6, 7 |  | $n_{\text {CK }}$ |  |

## Speed Bin Table Notes

## Absolute Specification ( $\mathrm{T}_{\text {OPER }} ; \mathrm{V}_{\mathrm{DDQ}}=\mathrm{V}_{\mathrm{DD}}=1.5 \mathrm{~V}+/-0.075 \mathrm{~V}$ );

1. The CL setting and CWL setting result in tCK(AVG).MIN and tCK(AVG).MAX requirements. When making a selection of tCK (AVG), both need to be fulfilled: Requirements from CL setting as well as requirements from CWL setting.
2. tCK(AVG).MIN limits: Since CAS Latency is not purely analog - data and strobe output are synchronized by the DLL - all possible intermediate frequencies may not be guaranteed. An application should use the next smaller JEDEC standard tCK (AVG) value ( $2.5,1.875,1.5$, or 1.25 ns ) when calculating CL [nCK] = tAA [ns] / tCK (AVG) [ns], rounding up to the next 'Supported CL'.
3. $\operatorname{tCK}(\mathrm{AVG}) . \mathrm{MAX}$ limits: Calculate tCK (AVG) = tAA.MAX / CLSELECTED and round the resulting tCK (AVG) down to the next valid speed bin (i.e. 3.3 ns or 2.5 ns or 1.875 ns or 1.25 ns ). This result is tCK(AVG).MAX corresponding to CLSELECTED.
4. 'Reserved' settings are not allowed. User must program a different value.
5. Any DDR3-1066 speed bin also supports functional operation at lower frequencies as shown in the table which are not subject to Production Tests but verified by Design/Characterization.
6. Any DDR3-1333 speed bin also supports functional operation at lower frequencies as shown in the table which are not subject to Production Tests but verified by Design/Characterization.
7. Any DDR3-1600 speed bin also supports functional operation at lower frequencies as shown in the table which are not subject to Production Tests but verified by Design/Characterization.
8. Hynix DDR3 SDRAM devices support down binning to $C L=7$ and $C L=9$, tAA/tRCD/tRPmin must be 13.125 ns or lower. SPD settings must be programmed to match. For example, DDR3 1333H devices supporting down binning to DDR3-1066F should program 13.125 ns in SPD bytes for tAAmin (Byte 16), tRCDmin (Byte 18), and tRPmin (Byte 20). DDR3-1600K devices supporting down binning to DDR3-1333H or DDR3 1600F should program 13.125 ns in SPD bytes for tAAmin (Byte 16), tRCDmin (Byte 18), and tRPmin (Byte 20). Once tRP (Byte 20) is programmed to 13.125 ns , tRCmin (Byte 21,23) also should be programmed accordingly. For example, 49.125ns (tRASmin + tRPmin $=36 \mathrm{~ns}+13.125$ ns ) for DDR3-1333H and 48.125 ns (tRASmin + tRPmin $=35 \mathrm{~ns}+13.125 \mathrm{~ns}$ ) for DDR3-1600K.

## Иทиіх

## Package Dimensions

## Package Dimension(x4/ x8); 82Ball Fine Pitch Ball Grid Array Outline



